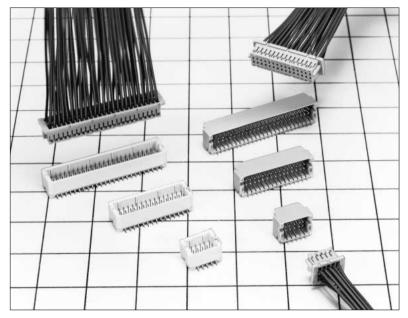
1 mm Pitch Double Rows Low Profile Board-to-Cable Connectors

DF20 series



Features

1. Contact Pitch

1 mm contact pitch allows reliable solder and cable termination.

2. Low profile

Total mating height above the board is 5.8 mm for the straight type and 5.5 mm for the right angle type.

3. Reliable electrical connection wipe

Effective electrical connection is assured with a 1mm wipe of mating contacts.

4. Narrower external width and length

Redesigned metal fittings decreased the overall length of the board- mount receptacle and permit end-to-end mounting of several connectors.

5. Automatic equipment board placement

Straight type pin headers are supplied with a 5.4 mm X 4.6mm flat platform to allow vacuum pick-up and placement on the board.

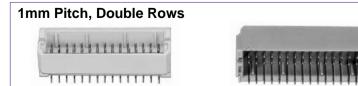
6. Product variations

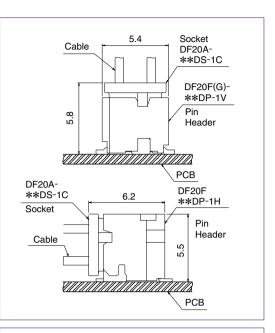
- (1) Available with 10, 20, 30, 40, and 50 contacts.
- (2) Pin headers are available in two types: with or without board positioning bosses.
- (3) Depending on specific application pin headers can be ordered in straight or right angle types.

Applications

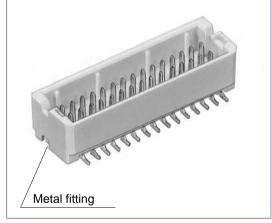
Notebook PC, small office automation equipment, small consumer devices, portable devices.

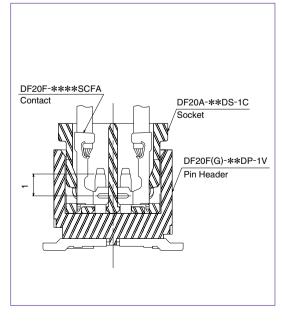
Any application requiring low profile reliable board-to-cable connection with a AWG #28, AWG#30, AWG#32 conductors.





Narrower external width and length





Product Specifications

	Rated current	AWG#28 : 1A AWG#30 : 0.9A	Operating temperature range	-35°C to 85°C (Note 1,2)	Storage temperature range	-10°C to 60°C (Note 2)
Rating	Rated voltage	AWG#32 : 0.7A 100V AC	Operating humidity range	20% to 80%	Storage humidity range	40% to 70%

Item	Specifications	Conditions
1.Insulation resistance	500MΩ min.	Measured at 100V DC
2.Withstanding voltage	No flashover or insulation breakdown	Conduction of 300V AC applied for 1 minute
3.Contact resistance	30MΩ max.	Measure at 100mA.
4.Insertion-Extraction force (per contact)	Min. 0.2 N (20 gf), Max. 2 N (200 gf)	Measured with a steel pin of 0.2 \pm 0.005 thickness
5.Vibration	No electrical discontinuity of 1µs min.	Frequency of 10 to 55 Hz, single amplitude of 0.75 mm, in 3 directions for 2hours
6.Humidity	Contact resistance of 30m Ω max., insulation resistance of 100M Ω min.	Temperature of $40\pm 2^{\circ}$ C, humidity of 90% to 95%, left standing for 96 hours
7.Temperature cycle	Contact resistance of 30m Ω max, insulation resistance of 500M Ω min.	(-55°C:30min → 5°C to 35°C: 2 to 3min → 85°C:30min → 5°C to 35°C:2 to 3min) for 5 cycles
8.Mechanical operation	Contact resistance of 30mΩ max.	50 cycles
9.Resistance to Soldering heat	No deformation of the insulator parts that will affect performance	Reflow: At the recommended temperature profile, manual solder: Soldering iron temperature of 300°C for 3 seconds

Note1: Includes temperature rise caused by current flow.

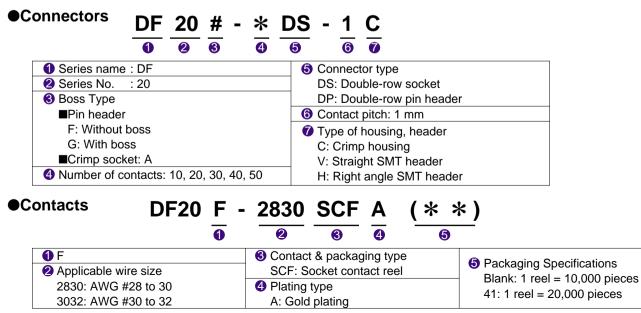
Note2: The term "storage" refers to products stored for long periods of time prior to mounting and use.

Operating temperature range and Humidity range covers non-conducting conditions of installed connectors in storage, shipment or transportation.

Materials

Item	Part	Material	Finish	Remarks
Socket	Insulator	Insulator Polyamide		UL94V-0
Socket contact	Contact	Phosphor bronze	Gold plating	
	Insulator	Polyamide	Color : Beige	UL94V-0
	Contact	Phosphor bronze	Gold plating	
Pin header	Metal Fitting	Brass	ass V type: Solder plating H type: Tin-Copper plating (P	

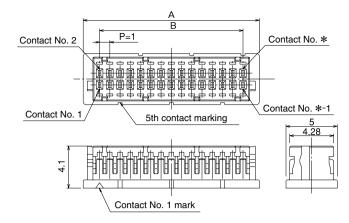
Ordering Information





Double Row Socket





Shown with terminated and installed contacts

_					Unit: mm
	Product No.	CL No.	Number of Contacts	А	В
	DF20A-10DS-1C	686-0020-3	10	7.2	4.0
	DF20A-20DS-1C	686-0021-6	20	12.2	9.0
	DF20A-30DS-1C	686-0022-9	30	17.2	14.0
Γ	DF20A-40DS-1C	686-0023-1	40	22.2	19.0
	DF20A-50DS-1C	686-0024-4	50	27.2	24.0

[Specifications number]-*, (**) (59): Gold plating, embossed tape packaging

Note: Sales quantities are by the package unit (containing 100 pieces). Please order by package unit.

Socket Crimp Contacts

Product No.	CL No.	Type of contacts	Quantity	Plating type
DF20F-2830SCFA(**)	686-0042-6-**	Decl.contecto	Saa anasificationa number column	Cold plating
DF20F-3032SCFA(**)	686-0043-9-**	Reel contacts	See specifications number column	Gold plating

[Specifications number] -*, (**) Blank 1 reel : 10,000 pieces 41 1 reel : 20,000 pieces

•Applicable Wire (Tin plated solid soft conductor)

Applicable Wire Size (Stranded wire conductor)	Jacket diameter
AWG #28 (7/0.127 mm)	
AWG #30 (7/0.1 mm)	0.5mm to 0.6 mm
AWG #32 (7/0.08 mm)	

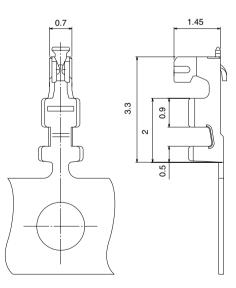
•Recommended wire UL1571 •Strip length 1.2 to 1.9 mm

Note: When using other than the recommended wire, contact your nearest Hirose representative.

•Applicable Crimping Tools

Туре	CL No.	Product No.
Applicator	901-4572-6	AP105-DF20-2830S
Press	901-0005-4	CM-105

Note 1: Hirose Electric will not be responsible for any problems caused by use of tools other than specified.

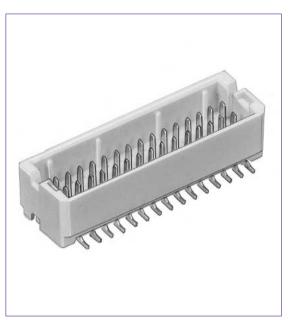


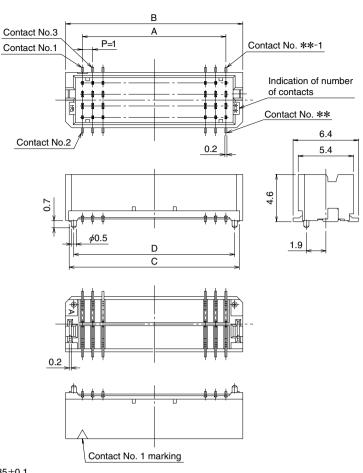
■Replacement Parts List for Applicator

Туре	Product No.	CL No.
Insulation crimper	AP105-DF20-2830S(61)	901-4572-6-61
Wire crimper	AP105-DF20-2830S(62)	901-4572-6-62
Insulation anvil and wire anvil	AP105-DF20-2830S(63)	901-4572-6-63



Double Row Straight Pin header





▶ PCB Footprints A±0.05 0.9±0.05 0.85±0.1 0.6±0.05 0.05±0.1

Note 1:Shaded area must be free of any electrically conductive traces to avoid contact with soldered pin header terminations. Note 2: Required only for pin headers supplied with the positioning boss.

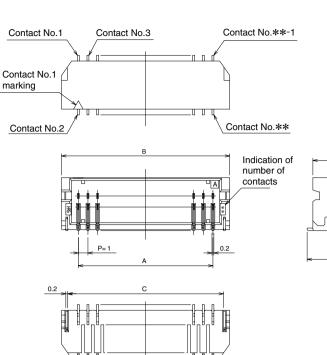
						_	Unit: min
Product No.	CL No.	Number of contacts	А	В	С	D	Remarks
DF20F-10DP-1V(**)	CL686-0032-2- * *	10	4.0	7.3	6.6		
DF20F-20DP-1V(**)	CL686-0033-5-**	20	9.0	12.3	11.6		
DF20F-30DP-1V (**)	CL686-0034-8-**	30	14.0	17.3	16.6	_	Without boss
DF20F-40DP-1V(**)	CL686-0035-0-**	40	19.0	22.3	21.6		
DF20F-50DP-1V (* *)	CL686-0036-3-**	50	24.0	27.3	26.6	_	
DF20G-10DP-1V(**)	CL686-0037-6-**	10	4.0	7.3	6.6	5.7	
DF20G-20DP-1V(**)	CL686-0038-9-**	20	9.0	12.3	11.6	10.7	
DF20G-30DP-1V(**)	CL686-0039-1-**	30	14.0	17.3	16.6	15.7	With boss
DF20G-40DP-1V(**)	CL686-0040-0-**	40	19.0	22.3	21.6	20.7	
DF20G-50DP-1V(**)	CL686-0041-3-**	50	24.0	27.3	26.6	25.7	
Note1: Order embossed ta	ape packaging items by	the reel. (1 reel conta	ains 1.000	pieces)		[Specificati	ons numberl-*. (**)

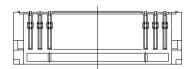
Note1: Order embossed tape packaging items by the reel. (1 reel contains 1,000 pieces) Note2: Vacuum pick-up platforms are included with embossed tape packaged connectors. [Specifications number]-*, (**) (59): Gold plating, embossed tape packaging



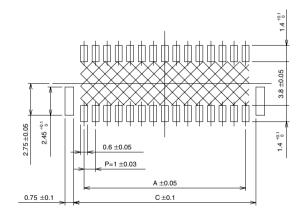
Double Row Right angle Pin header







PCB Footprints



Note : Shaded area must be free of any electrically conductive traces to avoid contact with soldered pin header terminations.

						Unit: mm
Product No.	HRS No.	Number of contacts	А	В	С	Remarks
DF20F -10DP-1H (* *)	686-0027-2 (* *)	10	4.0	7.5	6.2	
DF20F -20DP-1H (* *)	686-0028-5 (**)	20	9.0	12.5	11.2	
DF20F -30DP-1H (**)	686-0029-8 (* *)	30	14.0	17.5	16.2	Without boss
DF20F -40DP-1H (* *)	Reserved for product expansion	40	19.0	22.5	21.2	
DF20F -50DP-1H (* *)	Reserved for product expansion	50	24.0	27.5	26.2	

[Specifications number]-*, (**) (59): Gold plating, embossed tape packaging

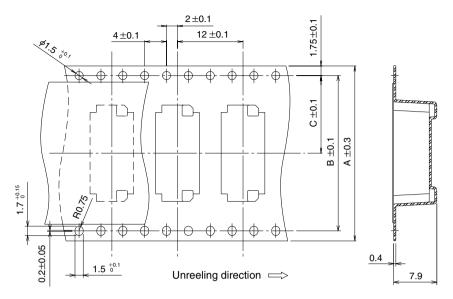
Note:Order embossed tape packaging items by the reel. (1 reel contains 1,000 pieces)

5.5

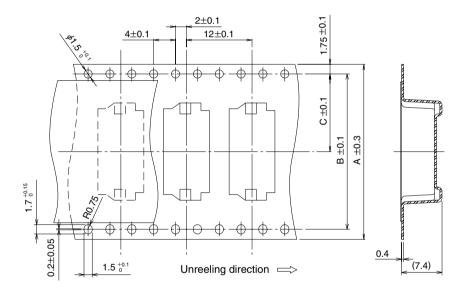
6.2

Embossed Carrier Tape Dimensions

•Straight pin header



Right angle pin header



Reel dimensions

	Product No.	Number of Contacts	А	В	С	D
	DF20F(G)-10DP-1V	10	16		7.5	16.4
	DF20F(G)-20DP-1V	20	24		11.5	24.4
	DF20F(G)-30DP-1V	30	32	28.4	14.2	32.4
	DF20F(G)-40DP-1V	40	44	40.4	20.2	44.4
	DF20F(G)-50DP-1V	50	44	40.4	20.2	44.4
	DF20F-10DP-1H	10	16		7.5	16.4
	DF20F-20DP-1H	20	24		11.5	24.4
	DF20F-30DP-1H	30	32	28.4	14.2	32.4
*	DF20F-40DP-1H	40	44	40.4	20.2	44.4
*	DF20F-50DP-1H	50	44	40.4	20.2	44.4

Product name label ϕ 1.5 mm diameter feed hole depth ϕ 21±0.8 2 ± 0.5 D^{+2}_{0}

* Reserved for product expansion

● Usage recommendation

1. Recommended Soldering					
Temperature Profile for IR Reflow.	Temperature	IR Reflow			
	250°C	Preheating: 150°C for 60 sec. to 120 sec. Soldering: 235°C±5°C for 10 sec. max. Maximum 240°C 220°C min. 10s to 30s 220°C	Maximum 240°C 220°C		
	200°C				
	150℃ —				
	100°C —	Preheating	Soldering		
	50°C _				
	0°C				
	08	Sec 50Sec 100Sec	150Sec 200Sec Time		
	•		sible under the same conditions, provided		
	Note 2: The ter	-	re between the first and second cycle. face temperature at the points of contacts		
2.Recommended Manual Soldering Conditions	Soldering ten	nperature: 290°C ±10°C, Solderir	ng time: within 3 sec.		
3. Recommended Solder Screen Thickness	0.15mm				
4. Board Warping	Maximum of 0.03	mm at the connector center section, with	h both ends of the connector as reference points.		
5. Cleaning Conditions	Refer to "Nylo	n Connector Use Handbook."			
6. Wiring Termination Conditions	Crimp contacts	n Connector Use Handbook." s should be handled with care as i erformance or termination.	not to cause any deformation or damage		
7. Mating / un-mating precautions	Excessive twisting and pulling on wires during mating/un-mating should be avoided as it may cause damage to connectors.				

